

Electronic Patent Application Fee Transmittal

Application Number:	10581500			
Filing Date:	02-Jun-2006			
Title of Invention:	Bonding Method, Device Formed by Such Method, Surface Activating Unit and Bonding Apparatus Comprising Such Unit			
First Named Inventor/Applicant Name:	Masuaki Okada			
Filer:	Ajay A. Jagtiani/g mills			
Attorney Docket Number:	YANE-0004-US1			
Filed as Large Entity				
U.S. National Stage under 35 USC 371 Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				
Extension - 1 month with \$0 paid	1251	1	130	130

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Total in USD (\$)				130